### **BGA622**

Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

**Small Signal Discretes** 



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#### BGA622, Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

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Previous Version: 2005-11-16

Page	Subjects (major changes since last revision)					
All	Document layout change					
-						

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Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

### 1 Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

#### **Feature**

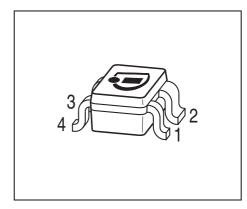
· High gain

 $|S_{21}|^2$  = 15.0 dB at 1.575 GHz

 $|S_{21}|^2$  = 14.2 dB at 1.9 GHz

 $|S_{21}|^2$  = 13.6 dB at 2.14 GHz

- Low noise figure, NF = 1.0 dB at 1.575 GHz
- Operating frequency range 0.5 6 GHz
- Typical supply voltage: 2.75 V
- On/Off-Switch
- Output-match on chip, input pre-matched
- Low part count
- 70 GHz f<sub>T</sub> Silicon Germanium technology
- 2 kV HBM ESD protection (Pin-to-Pin)
- Pb-free (RoHS compliant) package



**SOT343** 



#### **Applications**

LNA for GSM, GPS, DCS, PCS, UMTS, Bluethooth, ISM and WLAN

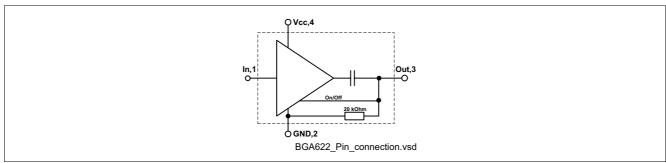


Figure 1 Pin connection

#### **Description**

The BGA622 is a wide band low noise amplifier, based on Infineon Technologies' Silicon Germanium Technology B7HF. In order to provide the LNA in a small package the out-pin is simultaneously used for RF out and On/Off switch. This functionality can be accessed using a RF-Choke at the Out pin, where a DC level of 0 V or an open switches the device on and a DC level of  $V_{\rm CC}$  switches the device off. While the device is switched off, it provides an insertion loss of 24 dB together with a high  $IIP_3$  up to 20 dBm.

Туре	Package	Marking		
BGA622	SOT343	BXs		

Note: **ESD:** Electrostatic discharge sensitive device, observe handling precaution



#### Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

#### **Maximum Ratings**

Table 1 Maximum ratings

Parameter	Symbol	Limit Value	Unit	
Voltage at pin $V_{\rm CC}$	$V_{CC}$	3.5	V	
Voltage at pin Out	$V_{out}$	4	V	
Current into pin In	$I_{in}$	0.1	mA	
Current into pin Out	$I_{out}$	1	mA	
Current into pin $V_{\rm CC}$	$I_{ m Vcc}$	10	mA	
RF input power	$P_{in}$	6	dBm	
Total power dissipation, $T_S$ < 139 °C <sup>1)</sup>	$P_{tot}$	35	mW	
Junction temperature	$T_{J}$	150	°C	
Ambient temperature range	$T_{A}$	-65 150	°C	
Storage temperature range	$T_{STG}$	-65 150	°C	
ESD capability all pins (HBM: JESD22-A114)	$V_{ESD}$	2000	V	

<sup>1)</sup>  $T_{\rm S}$  is measured on the ground lead at the soldering point

Note: All Voltages refer to GND-Node

#### Thermal resistance

Table 2 Thermal resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	300	K/W

<sup>1)</sup> For calculation of  $R_{\mathrm{thJA}}$  please refer to Application Note Thermal Resistance



**Electrical Characteristics** 

#### 2 Electrical Characteristics

# 2.1 Electrical characteristics at $T_{\rm A}$ = 25 °C (measured according to Figure 2) $V_{\rm CC}$ = 2.75 V, Frequency = 1.575 GHz, unless otherwise specified

**Table 3** Electrical Characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		<b>Test Condition</b>
Insertion power gain	$ S_{21} ^2$		15.0		dB	
Insertion power gain (Off-State)	$ S_{21} ^2$		-27		dB	
Input return loss (On-State)	$RL_{in}$		5		dB	
Output return loss (On-State)	$RL_{out}$		12		dB	
Noise figure ( $Z_{\rm S}$ = 50 $\Omega$ )	$F_{50\Omega}$		1.00		dB	f = 0.1 GHz
Input third order intercept point <sup>1)</sup> (On-State)	$IIP_3$		0		dBm	$\Delta f$ = 1 MHz, $P_{\text{IN}}$ = -28 dBm
Input third order intercept point <sup>1)</sup> (Off - State)	$IIP_3$		20		dBm	$\Delta f$ = 1 MHz, $P_{\text{IN}}$ = -8 dBm
Input power at 1 dB gain compression	$P_{ ext{-1dB}}$		-16.5		dBm	
Total device off current	$I_{tot ext{-off}}$	130	260	420	μΑ	$V_{\rm CC}$ = 2.75 V, $V_{\rm out}$ = $V_{\rm CC}$
Total device on current	$I_{tot ext{-on}}$	4.0	5.8	7.8	mA	$V_{\rm CC}$ = 2.75 V
On / Off switch control voltage	$V_{on}$	0		0.8	V	$V_{\rm CC}$ = 2.75 V ON-Mode: $V_{\rm out}$ = $V_{\rm on}$
	$V_{ m off}$	2.0		3.5	V	$V_{\rm CC}$ = 2.75 V OFF-Mode: $V_{\rm out}$ = $V_{\rm off}$

<sup>1)</sup>  $IP_3$  values depends on termination of all intermodulation frequency components. Termination used for this measurement is 50  $\Omega$  from 0.1 to 6 GHz



**Electrical Characteristics** 

# 2.2 Electrical characteristics at $T_{\rm A}$ = 25 °C (measured according to Figure 2) $V_{\rm CC}$ = 2.75 V, Frequency = 2.14 GHz, unless otherwise specified

**Table 4** Electrical Characteristics

Parameter	Symbol	l Values			Unit	Note /
		Min.	Тур.	Max.		<b>Test Condition</b>
Insertion power gain	$ S_{21} ^2$		13.6		dB	
Insertion power gain (Off-State)	$ S_{21} ^2$		-24		dB	
Input return loss (On-State)	$RL_{\sf in}$		7		dB	
Output return loss (On-State)	$RL_{out}$		10		dB	
Noise figure ( $Z_{\rm S}$ = 50 $\Omega$ )	$F_{50\Omega}$		1.05		dB	
Input third order intercept Point <sup>1)</sup> (On-State)	$IIP_3$		3		dBm	$\Delta f$ = 1 MHz, $P_{\text{IN}}$ = -28 dBm
Input third order intercept point <sup>1)</sup> (Off-State)	$IIP_3$		20		dBm	$\Delta f$ = 1 MHz, $P_{\text{IN}}$ = -8 dBm
Input power at 1 dB gain compression	$P_{ ext{-1dB}}$		-13		dBm	

<sup>1)</sup>  $IP_3$  values depends on termination of all intermodulation frequency components. Termination used for this measurement is 50  $\Omega$  from 0.1 to 6 GHz

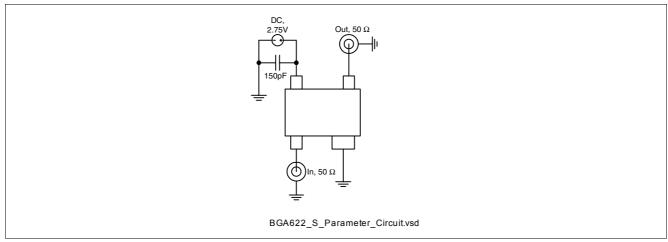


Figure 2 S-Parameter Test Circuit (loss-free microstrip test-fixture)



#### **Electrical Characteristics**

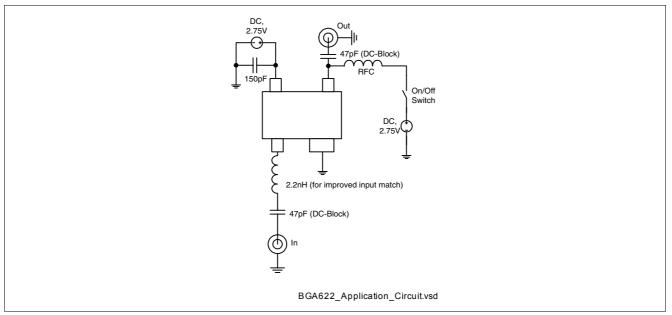


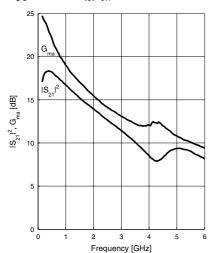
Figure 3 Application Circuit for 1800 - 2500 MHz



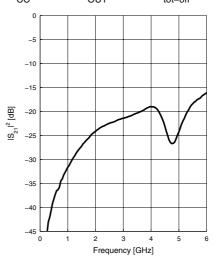
**Measured Parameters** 

#### **3** Measured Parameters

Power Gain 
$$|S_{21}|^2$$
,  $G_{ma} = f(f)$   
 $V_{CC} = 2.75V$ ,  $I_{tot-on} = 5.8mA$ 

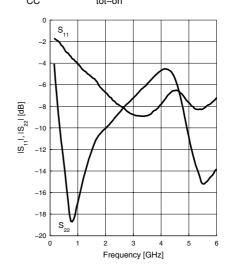


Off Gain 
$$IS_{21}^{2}I^{2} = f(f)$$
  
 $V_{CC} = 2.75V, V_{OUT} = 2.75V, I_{tot-off} = 0.3mA$ 



$$\begin{aligned} & \textbf{Reverse Isolation} \; |S_{12}| = f(f) \\ & V_{CC} = 2.75V, \; I_{tot-on} = 5.8 mA \end{aligned}$$

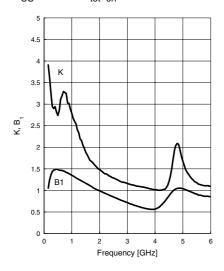
$$\begin{aligned} & \textbf{Matching} \ |S_{11}|, \ |S_{22}| = f(f) \\ & V_{CC} = 2.75V, \ I_{tot-on} = 5.8 \text{mA} \end{aligned}$$





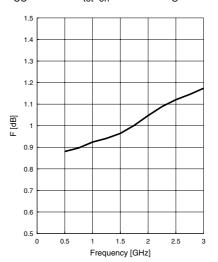
#### **Measured Parameters**

Stability K, B<sub>1</sub> = f(f)  
$$V_{CC} = 2.75V$$
,  $I_{tot-on} = 5.8mA$ 

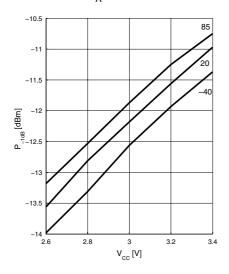


#### Noise Figure F = f(f)

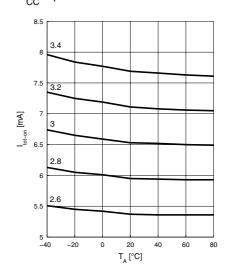
$$V_{CC} = 2.75V$$
,  $I_{tot-on} = 5.8mA$ ,  $Z_{S} = 50\Omega$ 



### $\begin{array}{l} \textbf{Input Compression Point P}_{-1dB} = f(V_{CC}) \\ f = 2.14 GHz, \, T_A = parameter \, in \, ^{\circ}C \end{array}$



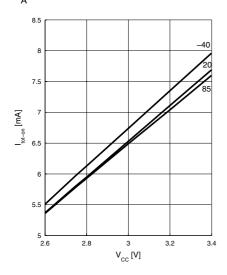
# $\begin{array}{l} \textbf{Device Current I}_{tot-on} = \textbf{f}(\textbf{T}_{A}, \ \textbf{V}_{CC}) \\ \textbf{V}_{CC} = \text{parameter in V} \\ \end{array}$



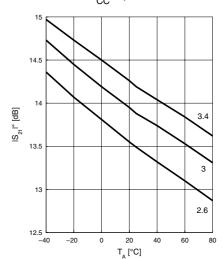


**Measured Parameters** 

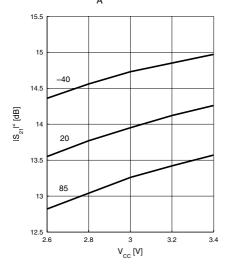
$$\begin{array}{l} \textbf{Device Current I}_{\text{tot-on}} = f(V_{CC}, \, T_{A}) \\ T_{A} = \text{parameter in } ^{\circ}C \end{array}$$



Power Gain 
$$|S_{21}|^2 = f(T_A, V_{CC})$$
  
f = 2.14GHz,  $V_{CC}$  = parameter in V



Power Gain 
$$|S_{21}|^2 = f(V_{CC}, T_A)$$
  
f = 2.14GHz,  $T_A$  = parameter in °C





**Package Information** 

### 4 Package Information

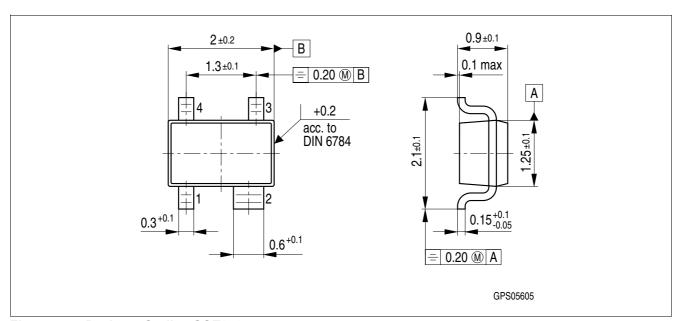


Figure 4 Package Outline SOT343

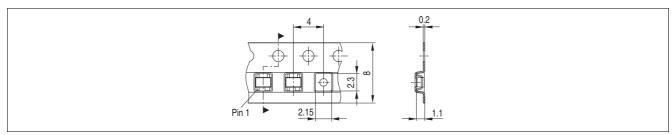


Figure 5 Tape for SOT343

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